



(1.00 mm) .0394"(SEI) (1.27 mm) .050"(SIBF)

## ONE-PIECE INTERFACE

## **SPECIFICATIONS**

For complete specifications and recommended PCB layouts see www.samtec.com?SEI www.samtec.com?SIBF

Insulator Material:

SEI = Liquid Crystal Polymer SIBF = Black Liquid Crystal Polymer
Contact Material:

Phosphor Bronze

Plating: SEI = Au over 50 μ" (1.27 μm) Ni SIBF = Au or Sn over 50 μ" (1.27 μm) Ni

Current Rating: SEI = 2.3 A per pin (1 pin powered) SIBF = 2.5 A per pin

(1 pin powered)
Operating Temp Range:

Operating Temp Range:
-55 °C to +125 °C

Mating Force:
SEI = 50 g (0.49 N) per contact

Voltage Rating:
SEI = 250 VAC/354 VDC
SIBF = 155 VAC/219 VDC

Cycles: SEI = 100 min

**Contact Deflection:** SEI = (0.46 mm) .018" nominal RoHS Compliant:

## **PROCESSING**

Lead-Free Solderable:

SMT Lead Coplanarity (SEI): (0.10 mm) .004" max (05-25) (0.15 mm) .006" max (30)\*

\*(.004" stencil solution may be available; contact ipg@samtec.com)
SMT Lead Coplanarity (SIBF):

(0.10 mm) .004" max (05-20) (0.15 mm) .006" max (25)\* \*(.004" stencil solution may be available; contact ipg@samtec.com)

## RECOGNITIONS

For complete scope of recognitions see .samtec.com/quality



